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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

ART UNIT:

2858

In re application of:

WARREN M. FAKNWORTH SALMAN AKRAM

Serial No.: 09/266,237

Filing Date: March 10, 1999

Title:

TEST INTERCONNECT FOR BUMPED SEMICONDUCTOR COMPONENTS METHOD

AND METHOD OF FABRICATION

Attorney Docket No.: 97-1433

REQUEST FOR CORRECTION ON THE FILING RECEIPT April 13, 1999

APPLICATION PROCESSING DIVISION'S CUSTOMER CORRECTION BRANCH Patent & Trademark Office Washington, D.C. 20231

Dear Sir:

Enclosed for correction is the Filing Receipt for the above application with the change noted thereon. Specifically, the word "and" needs to be added in the title.

If any fees are due, the Commissioner is authorized to deduct any fees from Deposit Account No. 07-1857. A duplicate copy of this sheet is enclosed.

Respectfully submitted:

Stephen A. Gratton

Registration No. 28,418 Attorney for Applicants

2764 South Braun Way Lakewood, CO 80228 (303) 989 6353

CERTIFICATE OF MAILING UNDER 37 C.F.R. §1.8

I hereby certify that this correspondence is being deposited with the United States Postal Service as first class mail, postage prepaid, in an envelope addressed to: APPLICATION PROCESSING DIVISION'S CUSTOMER CORRECTION BRANCH, Patents and Trademark Office, Washington, D.C. 20231 on this 13th day of April, 1999.

Date of Signature

Stephen A. Gratton, Attorney for Applicants



UNITED STATES ARTMENT OF COMMERCE Patent and Trademark Office ASSISTANT SECRETARY AND COMMISSIONER OF PATENTS AND TRADEMARKS Washington, D.C. 20231

AND

APPLICATION NUMBER	FILING DATE	GRP ART UNIT	FIL FEE REC'D	ATTORNEY DOCKET NO.	DRWGS	TOT CL	IND CL
09/266,237	03/10/99	2858	\$1,966.00	97-1433	10	48	12

STEPHEN A GRATTON 2764 SOUTH BRAUN WAY LAKEWOOD CO 80228

Receipt is acknowledged of this nonprovisional Patent Application 2.11, will the considered in its order and you will be notified as to the results of the examination. Be sure to provide the U.S. APPLICATION THAT BER, FILING DATE, NAME OF APPLICANT, and TITLE OF INVENTION when inquiring about this application. Fees transmitted by check or draft are subject to collection. Please verify the accuracy of the date presented on this receipt. If an arror is noted on this Filing Receipt, please write to the Application Processing Division's Customer Correction Branch within 10 days of receipt. Please provide a copy of the Filing Receipt with the changes noted thereon.

Applicant(s)

WARREN M. FARNWORTH, NAMPA, ID; SALMAN AKRAM, BOISE, ID.

IF REQUIRED, FOREIGN FILING LICENSE GRANTED 04/05/99
TITLE
TEST INTERCONNECT FOR BUMPED SEMICONDUCTOR COMPONENTS METHOD OF FABRICATION

PRELIMINARY CLASS: 324

DATA ENTRY BY: BELL, DOROTHY TEAM: 04

TEAM: 04 DATE: 04/05/99

(see reverse)